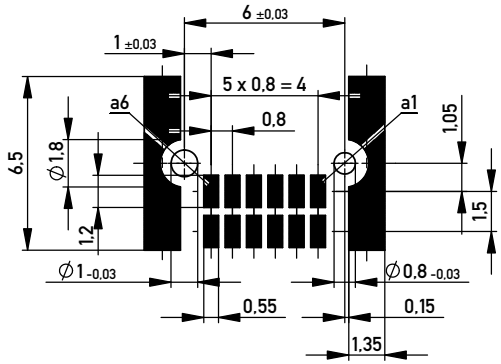
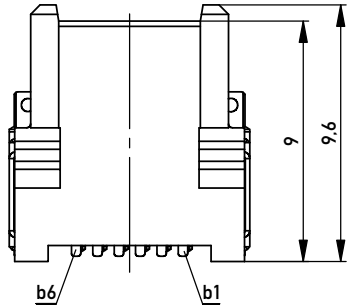
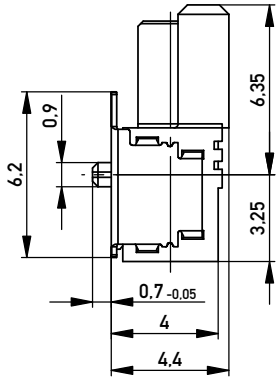
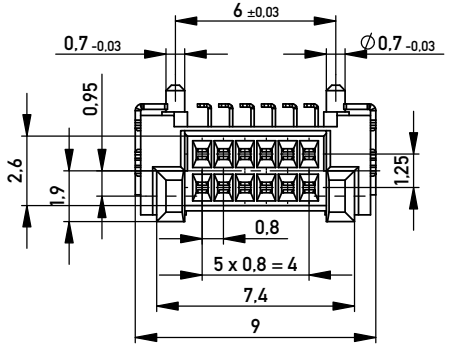
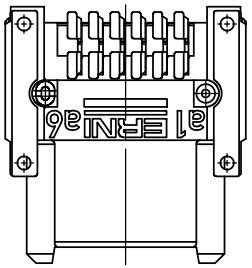
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT











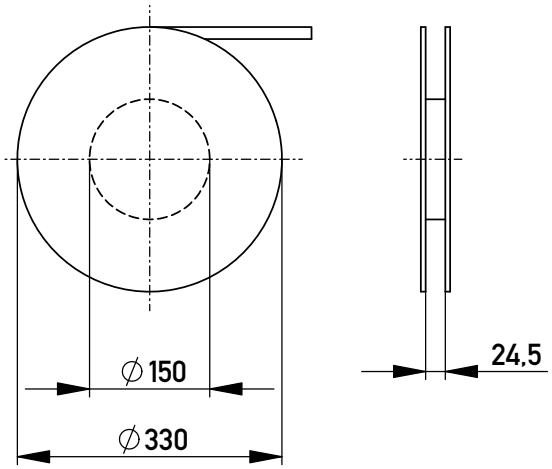
Anforderungsstufe 2
Performance Level 2

Kontaktbereich vergoldet
Mating Area gold plating

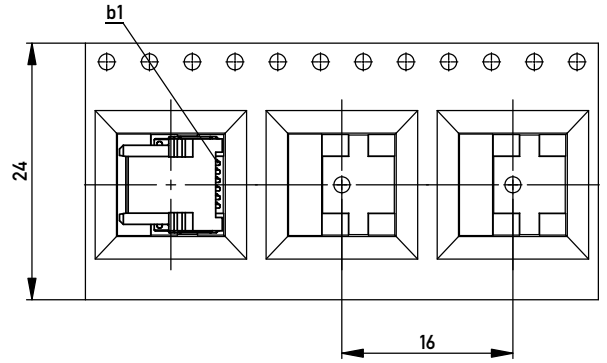
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt in Gurtverpackung - *Tape on Reel Packaging*
Verpackungseinheit: 650 Stück - *Packaging unit: 650 pcs*



Abspulrichtung - *Reel off Direction*



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Information:	Tolerances / All Dimensions in mm	Scale 5:1	
All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.	Subject to modification without prior notice. Drawing will not be updated.	Designation 0,8 DRC-Q, F 12 polig *0,8 DRC-Q, F 12 pin*	
e03 / Index / Date	ERNI www.ERNI.com	294251	I / A3
		Class DRCQ	